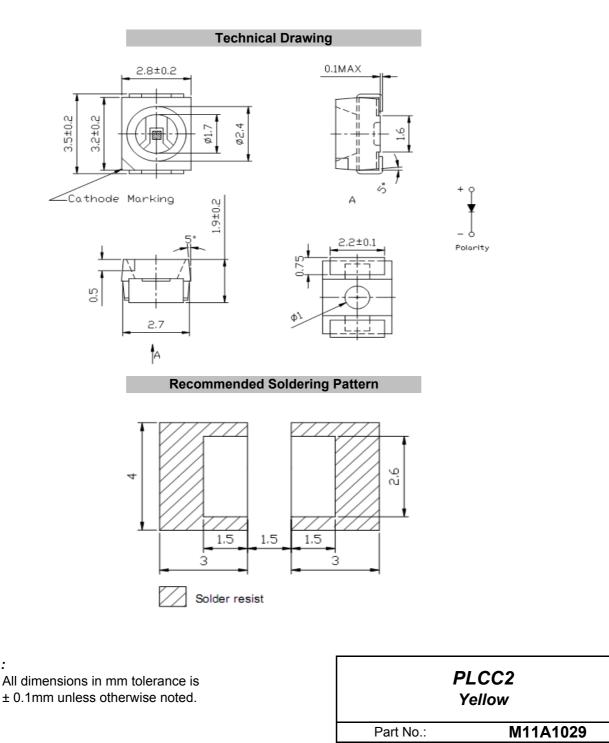




Applications



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Notes :





Absolute Maximum Ratings

Ta=25°C

Item	Symbol	 Unit
Power Dissipation	PD	 mW
DC Forward Current	I _F	 mA
Plused Forward Current	I _{FP} *	 mA
Reverse Voltage	V _R	 V
Operating Temperature	T _{OP}	 °C
Storage Temperature	T _{ST}	 °C

* 0.1 msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

I_F=20mA Ta=25°C

Ermitting Color		Yellow					
Material							
Forward Voltage	typ.		V _F				
r orward voltage	max.		V _F				
Wavelength	λD	580	nm				
-	λP	582	nm				
typ.	Δλ		nm				
Color Temperature	min.		K				
	max.		K				
Luminous Intensity *	min.	50	mcd				
Luminous intensity	typ.	80	mcd				
Reverse Current	max.		μA				
Viewing Angle	2Θ1/2	120					

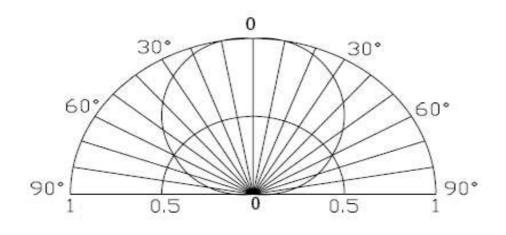
* Per NIST standards

						PLCC2 Yellow	
					Part No.: M11A1029		
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Directive Characteristics



						PLCC2 Yellow	
					Part No.: M11A1029		A1029
					Customer:		
DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
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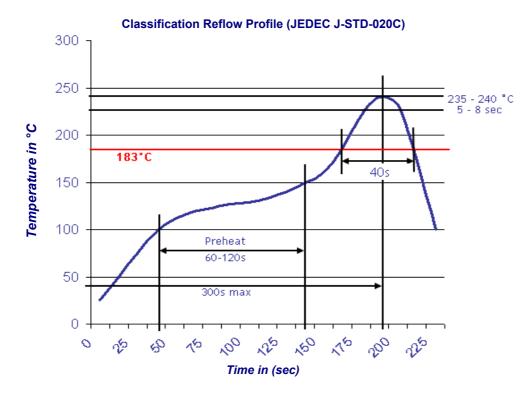
		PLCC2 Yellow					
					Part No.	.: M11	A1029
					Custome	er:	
DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
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Solder Condition

Lead Free Solder



				PLCC2 Yellow				
				Part No.: M11A1029				
				Customer:				
)	CHKD	Chang	MATL:	Chui	DATE	06.12.2009		
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Dong Ping

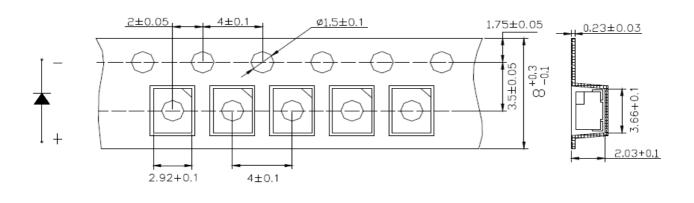
DRW:

APPD:

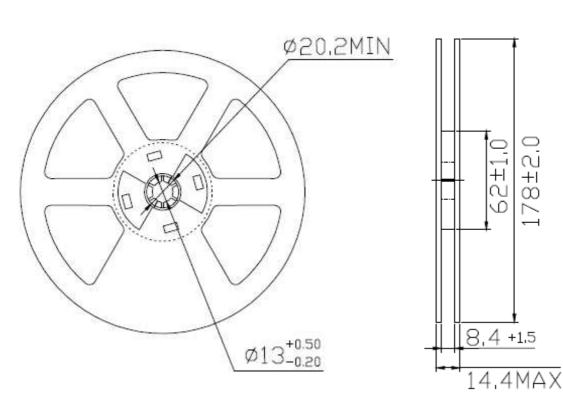




Packing Specifications



Reel Specifications



					PLCC2 Yellow				
					Part No.: M11A1029				
					Customer:				
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178±2.0

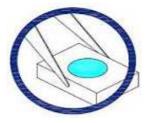




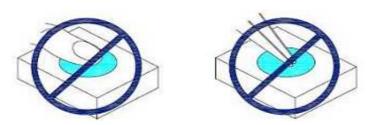
Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



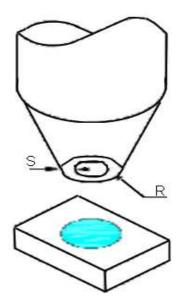
						PLCC2 Yellow	
					Part No.	: M11/	A1029
					Custome	r:	
DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
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- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



				PLCC2 Yellow			
			Part No.: M11A1029				
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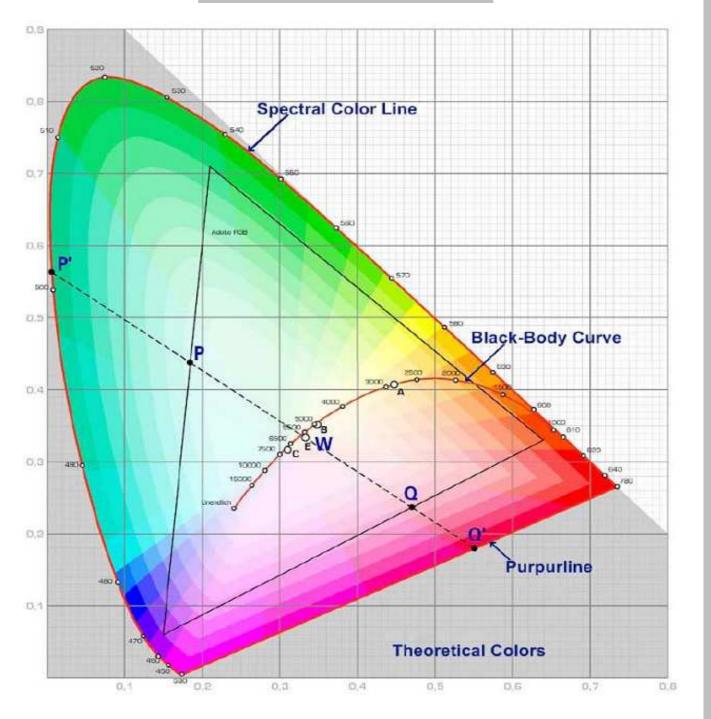
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Color table curve



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					Part No.: M11A1029		
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